10/10/2018 505135547

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
YING MA	08/29/2018
YIXI TIAN	08/29/2018
SHIH CHANG CHEN	09/27/2018
JIN SUN	09/04/2018
RODOLFO PEREZ	09/04/2018
STANLEY WU	09/10/2018

RECEIVING PARTY DATA

Name:	APPLIED MATERIALS, INC.	
Street Address:	3050 BOWERS AVENUE	
City:	SANTA CLARA	
State/Country:	CALIFORNIA	
Postal Code:	95054	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	16114558	

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	APPM/44015113US	
NAME OF SUBMITTER:	KEITH TABOADA	
SIGNATURE:	/Keith Taboada/	
DATE SIGNED:	10/10/2018	

PATENT REEL: 047125 FRAME: 0898 505135547

Total Attachments: 2

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PATENT REEL: 047125 FRAME: 0899

Atty Dkt No.: 44015113US01

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1)	Ying MA 19319 Garrison Avenue Castro Valley, California 94546	2)	Yixi TIAN 3050 Bowers Avenue Santa Clara, California 95054
3)	Shih Chang CHEN 3050 Bowers Avenue Santa Clara, California 95054	4)	Jin SUN 3050 Bowers Avenue Santa Clara, California 95054
5)	Rodolfo PEREZ 3050 Bowers Avenue Santa Clara, California 95054	6)	Stanley WU 1060 Canyon Hills Road San Ramon, California 94582

(hereinafter referred to as Assignors), have invented a certain invention entitled:

MEASUREMENT OF FLATNESS OF A SUSCEPTOR OF A DISPLAY CVD CHAMBER

for which application for Letters Patent in the United States was filed on August 28, 2018, under Serial No. 16/114,558, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, conventional, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any

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application therefore and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	8/29/2018 1:47;56 PM CDT	DocuSigned by: Uing ML F10998F9668B4EC Ying MA
2)	8/29/2018 7:55:16 PM CDT (DATE)	Pixi TIAN
3)	(DATE)	Shih Chang CHEN
4)	9/4/2018 11:03:13 AM CDT (DATE)	DocuSigned by: JIN SUN 96EF1277E9824E3 JIN SUN
5)	9/4/2018 2:03:49 PM CDT (DATE)	Poldto Perez 85624343592A450 Rodolfo PEREZ
6)	9/10/2018 3:50:55 PM CDT (DATE)	Stanley WU